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<b>AMENDMEN</b>	IT TRANSI	MITTAL LI	ETTER		Docket No. ROH-026
Application	n No.	Filing [		Examiner	Art Unit
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	IMAN & GRAUI	ER PLLC			TECHNOLOGY CENTER
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IN THE UNITED STATES PATENT AND TRADEMARK

e the Application of:

Shigeyuki UEDA

Application No.: 09/665,663

Filed: September 20, 2000

For:

Attorney Docket No.: ROH-026

PATENT APPLICATION

Examiner: W. D. Coleman

Art Unit: 2823

Confirmation No.: 5545

SEMICONDUCTOR CHIP AND METHOD OF PRODUCING THE SAME

## AMENDMENT under 37 CFR 1.111

Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

In response to the non-final Office Action dated November 18, 2002, the period for response being extended to May 18, 2003, by the Petition for Extension of Time filed herewith, please amend the above-identified application as follows:

## IN THE CLAIMS:

Please amend claims 11 and 12 as set forth below in clean form. Additionally, in accordance with 37 CFR 1.121(c)(1)(ii), amended claim(s) is/are set forth in a markedup version in the page(s) attached to this Amendment.

(Amended) A semiconductor chip adapted for electrical connection to an 11. external terminal, comprising:

a semiconductor chip body having a surface with internal wiring disposed thereon, at least one surface area of the internal wiring defining an external connection pad and at least one other surface area different from the at least one surface area of the internal wiring defining an internal connection pad, both the external connection pad and the internal connection pad facing in a same direction as the surface of the semiconductor chip body;

